

DATA SHEET

SURFACE MOUNT MULTILAYER CERAMIC CAPACITORS

Automotive grade X5R/X6S

\$12n\$F\$ to $~2.2~\mu$F$ RoHS compliant & Halogen Free



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SCOPE

This specification describes Automotive grade X5R/X6S series chip capacitors with lead-free terminations and used for automotive infotainment system.

<u>APPLICATIONS</u>

Entertainment applications Comfort applications Information applications

Do not use these products in application critical to passenger safety and car driving function

FEATURES

- AEC-Q200 complaint
- MSL class: MSL I
- · Soldering is compliant with J-STD-020D
- · Reduce environmentally hazardous waste
- High component and equipment reliability
- The capacitors are 100% performed by automatic optical inspection prior to taping.

ORDERING INFORMATION - GLOBAL PART NUMBER

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value.

GLOBAL PART NUMBER

AC <u>xxxx x x xxx x</u> B <u>x xxx</u>

(2) (3) (4) (5) (6) (7)

(I) SIZE - INCH BASED (METRIC)

0201 (0603) / 0402 (1005) / 0603 (1608) / 0805 (2012) / 1206 (3216)/ 1210 (3225)

(2) TOLERANCE

 $| = \pm 5\%$

 $K = \pm 10\%$

 $M = \pm 20\%$

(3) PACKING STYLE (SEE TABLE 5)

R = Paper/PE taping reel; Reel 7 inch

K = Blister taping reel; Reel 7 inch

P = Paper/PE taping reel; Reel 13 inch

F = Blister taping reel; Reel 13 inch

(4) TC MATERIAL

X5R

X6S

(5) RATED VOLTAGE

 $4 = 4 \ \lor$

5 = 6.3 V

6 = 10 V

7 = 16 V

8 = 25 V

G = 35 V

9 = 50 V

(6) PROCESS

B = Class 2 MLCC

(7) CAPACITANCE VALUE

2 significant digits + number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

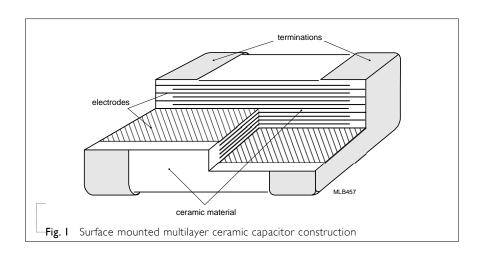
Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$



CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (Matte Sn). The terminations are leadfree. A cross section of the structure is shown in Fig. I.

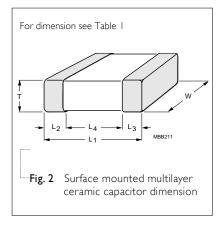


DIMENSION

Table I For outlines see fig. 2

TYPE	L _I (mm)	W (mm)	T (MM)	L ₂ / L ₃ (r	mm)	L ₄ (mm)
	1 ()	, , ()	. ()	min.	max.	min.
0201	0.6 ±0.03	0.3±0.03	0.3±0.03	0.10	0.20	0.20
0402	1.0 ±0.05	0.5 ±0.05	0.5 ±0.05	0.15	0.35	0.30
0603	1.6 ±0.10	0.8 ±0.10	0.8 ±0.10	0.20	0.60	0.40
	20.1010	125 1010	0.6 ±0.10		0.75	
0805	2.0 ±0.10	1.25 ±0.10	0.85 ±0.10	0.25		0.70
	2.0 ±0.20	1.25 ±0.20	1.25 ±0.20			
	3.2 ±0.15	17.1015	0.6 ±0.10		0.75	1.40
		1.6 ±0.15	0.85 ±0.10	0.25		
1206	22 . 020	17.1020	1.25 ±0.20			
	3.2 ±0.30	1.6 ±0.20	1.6 ±0.20			
	3.2 ±0.30	1.6 ±0.30	1.6 ±0.30			
	3.2 ±0.20	2.5 ±0.20	0.85 ±0.10			
	3.2 ±0.20	2,5 ±0,20	1.25 ±0.20			
1210	3.2 ±0.30	2.5 ±0.20	1.6 ±0.20	0.25	0.75	1.40
•	J.Z ±0.JU	∠,J ⊥∪,∠∪	2.0 ±0.20	0.23	0.75	1.10
	3.2 ±0.40	2.5 ±0.30	2.5 ±0.20			

OUTLINES





CAPACITANCE RANGE & THICKNESS FOR X5R

Table 2	Sizes from	n 0201 to 0402			
CAP.		0201		0402	0805
		6.3V	10V	6.3 V	50 V
15	5 nF	0.3±0.03	0.3±0.03		
22	2 nF	0.3±0.03	0.3±0.03		
33	3 nF	0.3±0.03	0.3±0.03		
47	7 nF	0.3±0.03	0.3±0.03		
68	3 nF	0.3±0.03	0.3±0.03		
100) nF	0.3±0.03	0.3±0.03		
150) nF			0.5±0.05	
220) nF			0.5±0.05	
330) nF			0.5±0.05	
470) nF			0.5±0.05	
680) nF			0.5±0.05	
1.0) uF			0.5±0.05	
2.2	2 uF				1.25±0.2

NOTE

1. Values in shaded cells indicate thickness class in mm

CAPACITANCE RANGE & THICKNESS FOR X6S

Sizes 020	I	
	0201	
	6.3V	10V
nF	0.3±0.03	0.3±0.03
nF		
uF		
	nF nF nF nF nF nF nF nF	6.3V nF

NOTE

- I. Values in shaded cells indicate thickness class in mm
- 2. Capacitance value of non E-6 series is on request







THICKNESS CLASSES AND PACKING QUANTITY

Table 4

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	- 1.11.01.41.1-00	DA CIVII	US 5005			QUANTIT	Y PER REEL	
SIZE CODE	THICKNESS	PACKII	NG CODE	TAPE WIDTH	Ø180 MI	M / 7 INCH	Ø330 M	M / 13 INCH
	CLASSIFICATION	7 INCH	13 INCH		Paper	Blister	Paper	Blister
0201	0.3 ±0.03 mm	R	Р	8 mm	15,000		50,000	
0402	0.5 ±0.05 mm	R	Р	8 mm	10,000		50,000	
0603	0.8 ±0.1 mm	R	Р	8 mm	4,000		15,000	
	0.6 ±0.1 mm	R	Р	8 mm	4,000		20,000	
0805	0.85 ±0.1 mm	R	Р	8 mm	4,000		15,000	
	1.25 ±0.2 mm	K	F	8 mm		3,000		10,000
	0.6 ±0.1 mm	R	Р	8 mm	4,000		20,000	
1206	0.85 ±0.1 mm	R	Р	8 mm	4,000		15,000	
1206	1.0/1.15 ±0.1 mm	K	F	8 mm		3,000		10,000
	1.25 ±0.2 mm	K	F	8 mm		3,000		10,000
	0.85 ±0.1 mm	K	F	8 mm		4,000		10,000
	1.15 ±0.1 mm	K	F	8 mm		3,000		10,000
1210	1.25 ±0.2 mm	K	F	8 mm		3,000		10,000
	2.0 ±0.2 mm	K		8 mm		2,000		
	2.5 ±0.2 mm	K		8 mm		1,000		



PAPER/PE TAPE SPECIFICATION

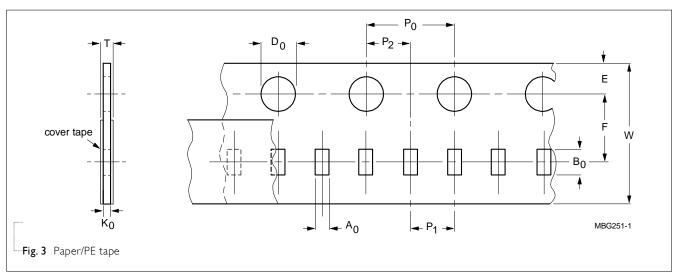


Table 5 Dimensions of paper/PE tape for relevant chip size; see Fig.3

SIZE	SYMBOL Unit: mm										
CODE	A ₀	B ₀	W	Е	F	$P_0^{(I)}$	P _I	P ₂	$ØD_0$	K ₀	Т
0201	0.39 ± 0.06	0.70 ± 0.06	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05	1.55 ± 0.03	0.38 ± 0.05	(0.47 / 0.55)±0.10
0402	0.70 ± 0.15	1.21 ± 0.12	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05	1.50 +0.1 /-0	(0.75 / 0.60)±0.10	(0.85 / 0.70)±0.10
0603	1.05 ± 0.14	1.86 ± 0.13	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(1.05 / 0.95 / 0.75)±0.10	(1.15 / 1.05 / 0.85)±0.10
0805	1.50 ± 0.15	2.26 ± 0.20	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(1.05 / 0.95 / 0.75)±0.10	(1.15 / 1.05 / 0.85)±0.10
1206	1.90 ± 0.15	3.50 ± 0.20	8.0 ± 0.20	1.75 ± 0.1	3.50 ± 0.05	4.0 ± 0.10	4.0 ± 0.10	2.0 ± 0.05	1.50 +0.1 /-0	(0.95 / 0.75)±0.10	(1.05 / 0.85)± 0.10

NOTE

1. P_0 pitch tolerance over any 10 pitches is $\pm 0.2 \text{ mm}$



BLISTER TAPE SPECIFICATION

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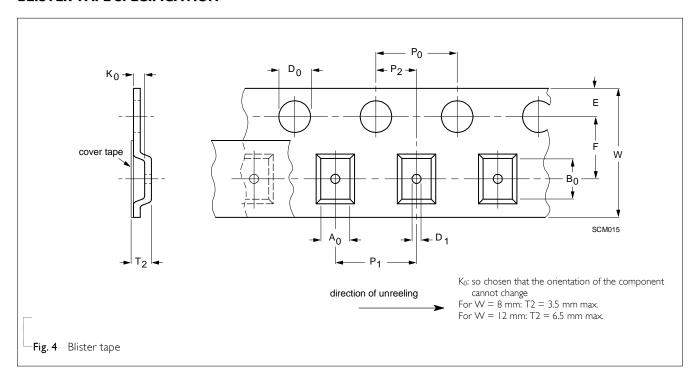


Table 6 Dimensions of blister tape for relevant chip size; see Fig.4

	SYMBOL Unit: n											it: mm				
SIZE CODE	A_0		B ₀		K_0		W	E	F	$ØD_0$	ØD _I	P ₀ (2)	P_{I}	P ₂	T2	
	Min.	Max.	Min.	Max.	Min.	Max.					Min.				Min.	Max.
0805	1.29	1.65	2.09	2.60	1.25	1.62	8.I ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	1 +0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.30	1.67
1206	1.65	2.12	3.30	3.75	1.22	2.15	8.I ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	1 +0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.27	2.20
1210	2.55	3.02	3.31	3.88	0.97	2.92	8.I ±0.20	1.75 ±0.1	3.5 ±0.05	1.5 +0.1/-0.0	1 +0.1/-0.0	4.0 ±0.10	4.0 ±0.10	2.0 ±0.05	1.02	2.97

NOTE

- I. Typical capacitor displacement in pocket
- 2. P_0 pitch tolerance over any 10 pitches is ± 0.2 mm





REEL SPECIFICATION

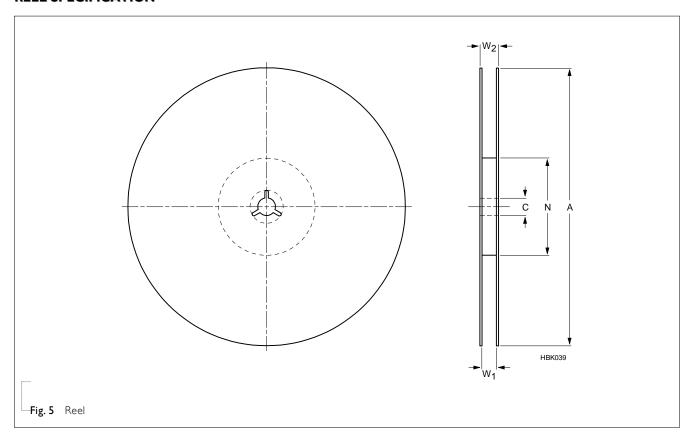


Table 7 Reel dimensions; see Fig.5

TARE VAURTU	SYMBOL						
TAPE WIDTH	A	N	С	Wı	W _{2max} .		
8 (Ø178 mm/7")	178 ±1.0	60 ±1.0	13 +0.50/-0.20	9.4 ±1.5	14.4		
8 (Ø330 mm/13")	330 ±1.0	100 ±1.0	13 +0.50/-0.20	9.0 ±0.2	14.4		
12 (Ø178 mm/7")	178 ±1.0	60 ±1.0	13 +0.50/-0.20	13.4 ±1.5	18.4		

PROPERTIES OF REEL

Material: polystyrene Surface resistance: $<10^{10}$ X/sq.



ELECTRICAL CHARACTERISTICS

X5RX6S DIELECTRIC CAPACITORS; NI/SIN TERMINATIONS

Unless otherwise specified, all test and measurements shall be made under standard atmospheric conditions for testing as given in 5.3 of IEC 60068-1:

- Temperature: 15 °C to 35 °C - Relative humidity: 25% to 75% - Air pressure: 86 kPa to 106 kPa

Before the measurements are made, the capacitor shall be stored at the measuring temperature for a time sufficient to allow the entire capacitor to reach this temperature.

The period as prescribed for recovery at the end of a test is normally sufficient for this purpose.

DESCRIPTION Table 8		VALUE			
Capacitance tolera	ance				±5% ⁽¹⁾ , ±10%, ±20%
Operating temper	erature range:				
X5R					−55 °C to +85 °C
X6S					-55 °C to +105 °C
•	ance change as a function of aracteristic/coefficient):	temperature			±15% ±22%
Dissipation factor	(D.F.)				
X5R	0201	0402	0603	0805	Spec.
6.3V	I2nF to I00nF	I20nF to IμF			≤7% ≤10%
10V	12nF to 100nF				≤10%
50V				2.2uF	≤10%
X6S	0201	0402			
6.3V	12nF to 100nF				≤10%
10V	12nF to 100nF				≤10%

Insulation resistance (I.R.)

X5R	0201	0402	0603	0805	25°C	I.R. × C (Ω.F.) Max. operating temperature
6.3V	12nF to 100nF	120nF to 1µF			≥100	≥10
10V	12nF to 100nF				≥100	≥10
50V				2.2uF	≥50	≥5
X6S	0201	0402				
6.3V	12nF to 100nF				≥100	≥10
10V	12nF to 100nF				≥100	≥10

NOTE

I. Capacitance tolerance ±5% doesn't available for X5R/X6S full product range, please contact local sales force before order





Surface-Mount Ceramic Multilayer Capacitors | Automotive grade | x5R/X6S | 4V to 50 V

SOLDERING RECOMMENDATION

Table 9

SOLDERING	SIZE					
METHOD	0201	0402	0603	0805	1206	≥ 1210
Reflow	Reflow only	≥ 0.1 µF	≥ 1.0 µF	≥ 2,2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave		< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	

SOLDERING CONDITIONS

The lead free MLCCs are able to stand the reflow soldering conditions as below:

(17E

- Temperature: above 220 °C
- Endurance: 95 to 120 seconds
- Cycles: 3 times

The test of "soldering heat resistance" is carried out in accordance with the schedule of "MIL-STD-202G-method 210F", "The robust construction of chip capacitors allows them to be completely immersed in a solder bath of 260 °C for 10 seconds". Therefore, it is possible to mount MLCCs on one side of a PCB and other discrete components on the reverse (mixed PCBs). Surface Mount Capacitors are tested for solderability at 245 °C during 2 seconds. The test condition for no leaching is 260°C for 30 seconds.

TESTS AND REQUIREMENTS

Table 10 Test procedures and requirements

NO	AEC-Q2000 TEST	TEST METHOD	REQUIREMENTS
ı	Pre-and Post-stress Electrical Test		
		Preconditioning;	No visual damage
	Temperature Cycling	150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature 1000 cycles with following detail:	ΔC/C ±10%
2		15 minutes at –55 °C	D.F. meet initial specified value
		15 minutes at 125 °C Recovery time 24 ±4 hours	I.R. meet initial specified value
3	Destructive Physical Analysis	Only applies to SMD ceramics. Electrical test not required.	



NO	AEC-Q2000 TEST	TEST METHOD	REQUIREMENTS
4	Humidity Bias	 Preconditioning: 150 +0/-10 °C /I hour, then keep for 24 ± I hour at room temp Initial measure: Parameter: I.R. Measuring voltage: I.3V ± I.5 Volts Note: Series with I00 KΩ Test condition: 85 °C, 85% R.H. connected with I00 KΩ resistor, applied I.5V/U_r for I,000 hours. Recovery: 24 ±2 hours Final measure: C.D.I.R. 	No visual damage after recovery $\Delta C/C \pm 15\%$ D.F. Less than 200% of initial spec. I.R. The insulation resistance shall be greater than 10% of initial spec.
5	High Temperature Operational Life	 Preconditioning: 150 +0/-10 °C /I hour, then keep for 24 ±1 hour at room temp Initial measure: Spec: refer to initial spec C, D, I.R Endurance test: Temperature: X5R:85 °C X6S:105 °C Specified stress voltage applied for I,000 hours:	No visual damage ΔC/C: ±20% D.F. Less than 200% of initial spec. I.R. The insulation resistance shall be greater than 10% of initial spec
6	External Visual	Any applicable method using × 10 magnification	In accordance with specification
7	Physical Dimension	Verify physical dimensions to the applicable device specification.	In accordance with specification
8	Resistance to Solvents	Per MIL-STD-202 Method 2 I 5 Solvent I : I part (by volume) of isopropyl alcohol 3 parts (by volume) of mineral spirits Solvent 2 : Terpene defluxer Solvent 3 : 42 parts (by volume) of water I part (by volume) of propylene glycol monomethyl ether I part (by volume) of monoethanolamine	No visual damage $\Delta C/C \pm 10\%$ D.F.: Within initial spec. I.R.: Within initial spec.

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NO	AEC-Q2000 TEST	TEST METHOD	REQUIREMENTS
9	Mechanical Shock	Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500 g's Duration: 0.5 ms Velocity change: 15.4 ft/s Waveform: Half-sin	$\Delta C/C \pm 10\%$ D.F. Within initial specified value I.R. Within initial specified value
10	Vibration	5 g's for 20 minutes, 12 cycles each of 3 orientations. 10-2000 Hz.	$\Delta C/C \pm 10\%$ D.F: meet initial specified value I.R. meet initial specified value
11	Resistance to Soldering Heat	Precondition: $150 \pm 0/-10$ °C for I hour, then keep for 24 ± 1 hours at room temperature Preheating for size ≤ 1206 : 120 °C to 150 °C for I minute Preheating for size ≥ 1206 : 100 °C to 120 °C for I minute and 170 °C to 200 °C for I minute Solder bath temperature: 260 ± 5 °C Dipping time: 10 ± 0.5 seconds Recovery time: 24 ± 2 hours Dissolution of the end fare plating shall not exceed 200 of the length of the edge concerned $\Delta C/C \pm 10\%$ D.F. within initial specified value	
12	ESD	Per AEC-Q200-002 A component passes a voltage level if all components stressed at that voltage level pass. YNM0053-1 FAIL PASS F	

NO	AEC-Q2000 TEST		TEST METHOD	REQUIREMENTS
13	Solderability		 Preheat at 155°C for 4 hours. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C. Should be placed into steam aging for 8 hours±15 minutes. After preheating, immerse the capacitor in a solution of ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 5+0/-0.5 seconds at 235±5°C. Should be placed into steam aging for 8 hours±15 minutes. After preheating, immerse the capacitor in a solution of Ethanol and rosin (25% rosin in weight proportion). Immerse in eutectic solder solution for 30±5 seconds at 260±5°C. 	The solder should cover over 95% of the critical area of each termination.
14	Electrical Characterization	Capacitance Dissipation Factor (D.F.) Insulation Resistance (I.R.) Temperature coefficient	At 25°C, 24 hours after annealing f = I KHz, measuring at voltage I Vrms at 25 °C At 25°C, 24 hours after annealing f = I KHz, measuring at voltage I Vrms at 25 °C At Ur (DC) for I minute Capacitance shall be measured by the steps shown in the following table. The capacitance change should be measured after 5 min at each specified temperature stage. Step Temperature(°C) a 25±2 b Lower temperature±3°C c 25±2 d Upper Temperature±2°C e 25±2 Capacitance Change shall be calculated from the formula as below ΔC = C1 × 100% C1: Capacitance at step c C2: Capacitance at step b or d I. Specified stress voltage applied for 1~5 seconds 2. Ur ≤ 50 V: series applied 2.5 Ur Charge/Discharge current is less than 50 mA	In according with specification on Table 8 In according with specification on Table 8 Δ C/C X5R: ±15% X6S: ±22% No breakdown or flashover

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NO	AEC-Q2000 TEST	TEST METHOD	REQUIREMENTS
15	Board Flex	Part mounted on a 100 mm X 40 mm FR4 PCB board, which is 1.6 ±0.2 mm thick and has a layer-thickness 35 µm ± 10 µm. Part should be mounted using the following soldering reflow profile. Conditions: Test Substrate:	No visible damage △C/C X5R/X6S: ±10% Dimension(mm) Type a b c 0201 0.3 0.9 0.3 0402 0.4 1.5 0.5 0603 1.0 3.0 1.2 0805 1.2 4.0 1.65 1206 2.2 5.0 1.65 1210 2.2 5.0 2.0
16	Terminal Strength	With the component mounted on a PCB obtained with the device to be tested, apply a 17.7N (1.8Kg) force to the side of a device being tested. This force shall be applied for 60+1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. * Apply 2N force for 0402 size. * Apply 1N force for 0201 size. Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body, terminals and body/terminal junction. Before, during and after the test, the device shall comply with all electrical requirements stated in this specification.	



Product specification 15 16

Surface-Mount Ceramic Multilayer Capacitors | Automotive grade x5R/X6S 4V to 50 V

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 0	Oct. 06, 2021	-	- New

[&]quot;YAGEO reserves all the rights for revising the content of this datasheet without further notification, as long as the products itself are unchanged. Any product change will be announced by PCN."



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